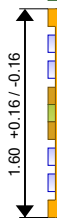


Layer	Stack up	Supplier	Supplier Description	Description	Type	Tg	εr	Base Thickness	Processed Thickness
	[1]								
1		Electra Polymers		Liquid PhotoImageable Mask	SolderMask			4.000	
		Circuitfoil		Copper Foil	Copper			0.018	0.036
2		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.069
3		Shanghai Nanya	NY2150	PrePreg 7628	Dielectric	150.000	4.200	0.187	0.183
		Shanghai Nanya	NY2150	NY2150 Core	FR4	150.000	4.200	0.350	0.350
		Shanghai Nanya	NY2150	PrePreg 7628	Dielectric	150.000	4.200	0.035	0.035
		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.187	0.183
		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.069
4		Circuitfoil		Copper Foil	Copper			0.018	0.036
		Electra Polymers		Liquid PhotoImageable Mask	SolderMask			4.000	
	[4]								



Copper Thickness = 0.142 | Dielectric Thickness = 0.854 | Solder Mask Thickness = 0.050 | Stack Up Thickness = 0.996 | Stack Up Thickness with Soldermask = 1.046 | Stack Up Cost = 20.00 |

Notes

StackName: Mlb4_1.0mm_TraX	Version:	Revision:	Modification:	Date of Revision:	Editor	Page 1/1
Date: 11/2/2016	Associated Documents:					
Author: H. Ndala						
Department: CAM						
Site: Diep River						